

RADIANCE PLUS BONDING INSTRUCTIONS



- Prepare teeth using standard office protocol.
- Firmly press adhesive into back of bracket.
- Seat bracket on tooth with enough pressure to express perimeter "flash".
- Polymerize adhesive pursuant to your curing light instructions.
- Use a standard utility pliers to remove Visual Placement Aid (VPA) by its tail.

RADIANCE PLUS DEBONDING INSTRUCTIONS

Using Radiance Plus Debonding Pliers REF001-343E:

- Remove any remaining adhesive flash not removed at initial bonding with a debonding bur.
- Place the opposing tips of pliers occlusal/gingival under the tie wings.
- Apply constant pressure to the handles of the pliers.
- Gently move the angle of the pliers to the occlusal or gingival of the tooth with increasing force until the Radiance Plus bracket releases from the tooth.

#001-408 Replacement tips (Qty 2 with wrench)

Tips are easily replaced and should be disinfected prior to use.

Using Omega "Sushi" Ceramic Debonding Pliers REF001-301E:

- Remove any remaining adhesive flash not removed at initial bonding with a debonding bur.
- Place blades of recommended debonding instrument along the enamel/adhesive interface, occlusal/gingival for upper centrals, mesial/distal for all other brackets.
- Squeeze handles slowly until bracket releases from the tooth.

SCAN FOR



DEBONDING
DEMONSTRATION